

NOTES:

1) MATERIAL:

HOUSING: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
INSULATOR: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE: .012/ 0.30 THICK

2) FINISH:

TERMINALS:

SELECT GOLD IN CONTACT AREA: 50 MICROINCHES/ 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES/ 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES/ 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAIL AREA.

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43223-001.

4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TRAYS PER MOLEX
PACKAGING SPECIFICATION PK-43249-004.

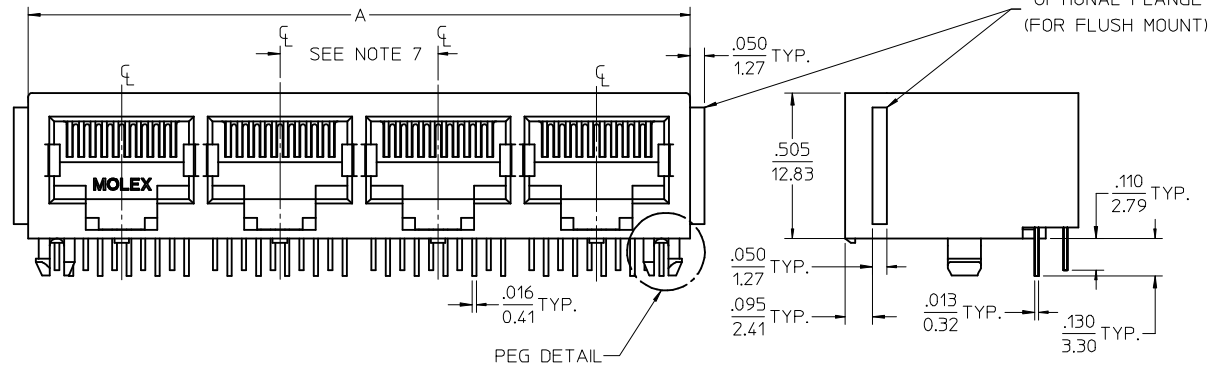
5) SEE SHEETS 4-6 FOR P.C. BOARD LAYOUTS.

6) SEE SHEET 2 FOR THE SHIELDED JACK ASSEMBLY.

7) FOR 6 CIRCUIT JACKS CENTERLINE TO CENTERLINE SPACING IS .448/ 11.38, FOR 8 CIRCUIT JACKS CENTERLINE TO CENTERLINE SPACING IS .550/ 13.97.

8) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.

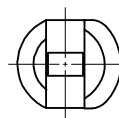
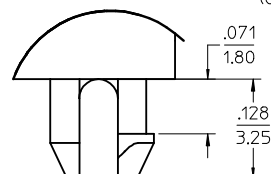
9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.



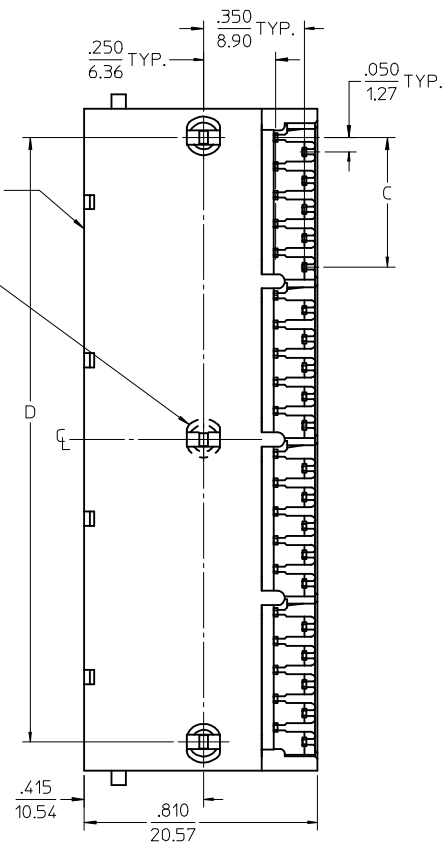
4 PORT 8 LOADED
10 JACK SHOWN

UNSHIELDED GANGED JACK ASSEMBLY
SEE SHEET 3

CENTER PEG
(8 PORT ASSY. ONLY)



SNAP-FIT
PEG DETAIL
SCALE 8:1



6 CIRCUIT HOUSING

CIRCUIT SIZE	NO. OF PORTS	DIM. A	DIM. C	DIM. D
6	2	.985 (25.02)	.250 (6.35)	.848 (21.54)
4	2	.985 (25.02)	.150 (3.81)	.848 (21.54)
2	2	.985 (25.02)	.050 (1.27)	.848 (21.54)
6	3	1.433 (36.40)	.250 (6.35)	1.296 (32.92)
4	3	1.433 (36.40)	.150 (3.81)	1.296 (32.92)
2	3	1.433 (36.40)	.050 (1.27)	1.296 (32.92)
6	4	1.881 (47.78)	.250 (6.35)	1.744 (44.30)
4	4	1.881 (47.78)	.150 (3.81)	1.744 (44.30)
2	4	1.881 (47.78)	.050 (1.27)	1.744 (44.30)
6	5	2.329 (59.16)	.250 (6.35)	2.192 (55.68)
4	5	2.329 (59.16)	.150 (3.81)	2.192 (55.68)
2	5	2.329 (59.16)	.050 (1.27)	2.192 (55.68)
6	6	2.777 (70.54)	.250 (6.35)	2.640 (67.06)
4	6	2.777 (70.54)	.150 (3.81)	2.640 (67.06)
2	6	2.777 (70.54)	.050 (1.27)	2.640 (67.06)
6	8	3.673 (93.29)	.250 (6.35)	3.536 (89.81)
4	8	3.673 (93.29)	.150 (3.81)	3.536 (89.81)
2	8	3.673 (93.29)	.050 (1.27)	3.536 (89.81)

8 CIRCUIT HOUSING

CIRCUIT SIZE	NO. OF PORTS	DIM. A	DIM. C	DIM. D
10	2	1.200 (30.48)	.450 (11.43)	1.000 (25.40)
8	2	1.200 (30.48)	.350 (8.89)	1.000 (25.40)
6	2	1.200 (30.48)	.250 (6.35)	1.000 (25.40)
10	3	1.750 (44.45)	.450 (11.43)	1.550 (39.37)
8	3	1.750 (44.45)	.350 (8.89)	1.550 (39.37)
6	3	1.750 (44.45)	.250 (6.35)	1.550 (39.37)
4	3	1.750 (44.45)	.150 (3.81)	1.550 (39.37)
10	4	2.300 (58.42)	.450 (11.43)	2.100 (53.34)
8	4	2.300 (58.42)	.350 (8.89)	2.100 (53.34)
4	4	2.300 (58.42)	.150 (3.81)	2.100 (53.34)
4	5	2.850 (72.39)	.150 (3.81)	2.650 (67.31)
10	5	2.850 (72.39)	.450 (11.43)	2.650 (67.31)
8	5	2.850 (72.39)	.350 (8.89)	2.650 (67.31)
10	6	3.400 (86.36)	.450 (11.43)	3.200 (81.28)
8	6	3.400 (86.36)	.350 (8.89)	3.200 (81.28)
10	8	4.500 (114.30)	.450 (11.43)	4.300 (109.22)
8	8	4.500 (114.30)	.350 (8.89)	4.300 (109.22)

ADD BLOCK TOL
EC NO: UCP2009-0477
DRWN: BELL 2008/09/05
CHKD: BELL 2008/09/11
APPR: FSMITH 2008/09/11

REV
K1

QUALITY SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± .005	± .0005
3 PLACES	± .005	± .0005
2 PLACES	± 0.038	± .0015
1 PLACE	± .005	± .0005

ANGULAR ± 1/2°

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
IN/MM

DRAWN BY DATE
JTR 1993/10/18

CHECKED BY DATE
JTR 1993/10/18

APPROVED BY DATE
RAS 1993/10/18

MATERIAL NO.
SEE SHTS 3

SIZE
C

SCALE
3:1

DESIGN UNITS
INCH

THIRD ANGLE PROJECTION

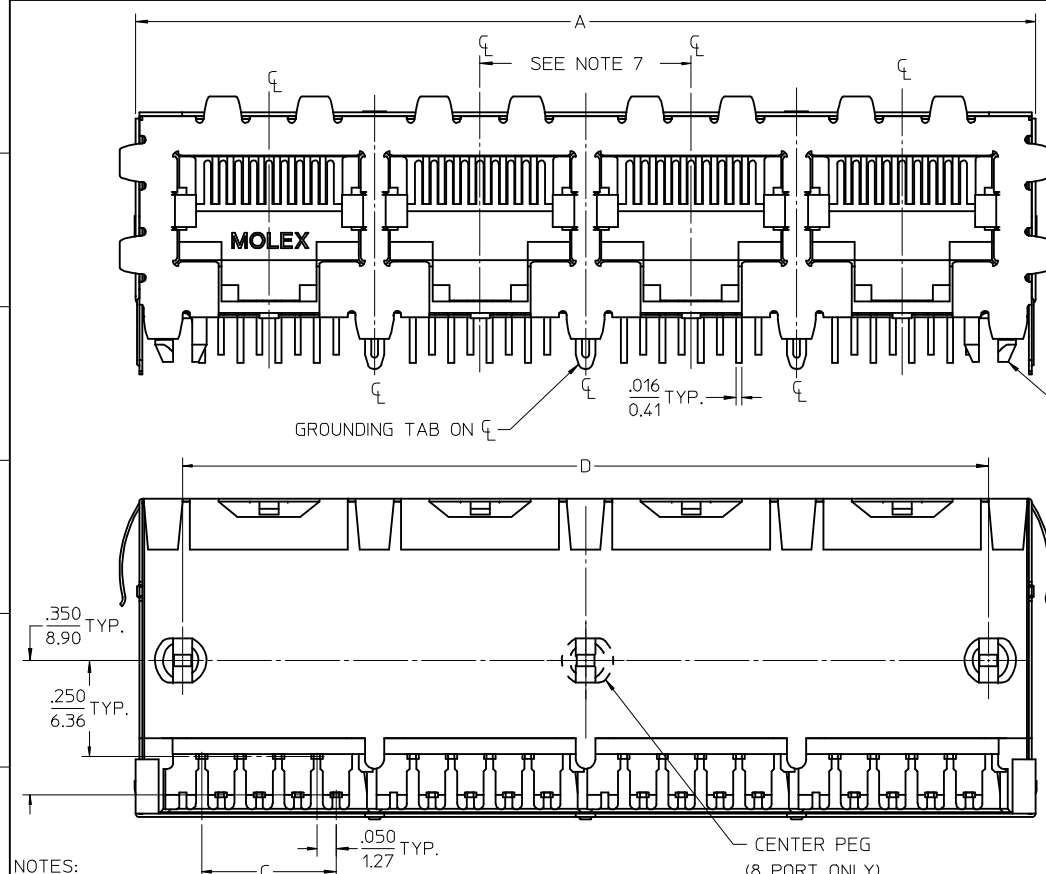
LOW PROFILE GANGED,
RIGHT ANGLE MODULAR JACK
ASSEMBLY

MOLEX INCORPORATED

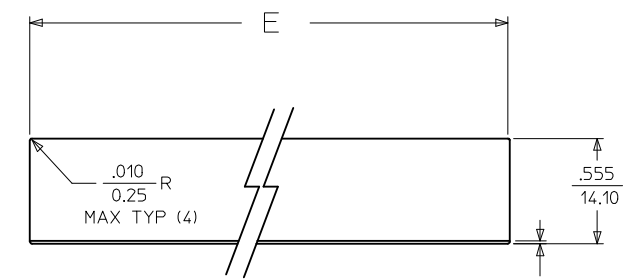
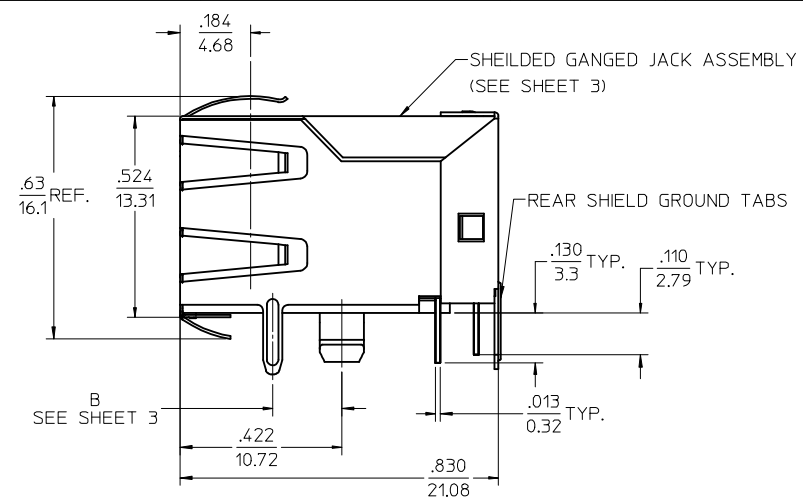
DOCUMENT NO.
SDA-43223

SHEET NO.
1 OF 6

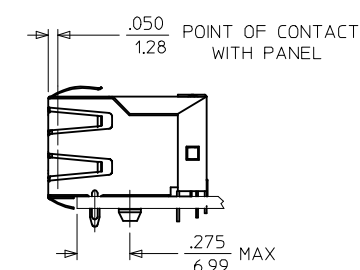
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION



- NOTES:
- 1) MATERIAL:
HOUSING: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
INSULATOR: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE: .012/ 0.30 THICK
SHIELD: BRASS, FRONT .007/ 0.18 THICK, REAR .010/ 0.25 THICK
 - 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES/ 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES/ 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES/ 1.27 MICROMETERS MIN.
SHIELD:
*100 MICROINCHES/ 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES/ 1.27 MICROMETERS COPPER UNDERPLATE. PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAIL AND/OR SHIELD.
 - 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43223-001.
 - 4) PACKAGING SPECIFICATION:
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44150-004.
 - 5) SEE SHEETS 4-6 FOR P.C. BOARD LAYOUTS.
 - 6) REAR SHIELD IS AVAILABLE WITH (1) CENTERED GROUND TAB ON 4 & 8 PORT VERSIONS.
 - 7) 8 CIRCUIT JACKS CENTERLINE TO CENTERLINE SPACING IS .550/ 13.97.
 - 8) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.



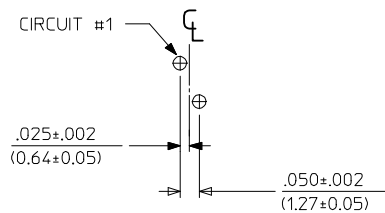
SCALE : 2/1



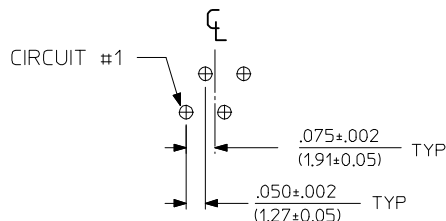
4 PORT 8 LOADED
8 JACK SHOWN

HOUSING SIZE	CIRCUIT SIZE	NO. OF PORTS	DIM. A	DIM. C	DIM. D	DIM. E
8	8	2	1.224 (31.09)	.350 (8.89)	1.000 (25.40)	1.255 (31.88)
8	8	4	2.324 (59.03)	.350 (8.89)	2.100 (53.34)	2.355 (59.82)
8	8	6	3.424 (86.97)	.350 (8.89)	3.200 (81.28)	3.455 (87.76)
8	8	8	4.524 (114.91)	.350 (8.89)	4.300 (109.22)	4.555 (115.97)
8	2	8	4.524 (114.91)	.050 (1.27)	4.300 (109.22)	4.555 (115.97)

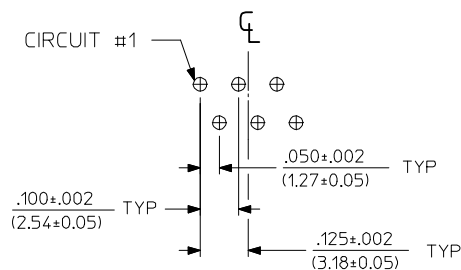
SEE SHEET 1 EC NO: UCP2009-0477 DRWN:JBELL CHKD:JBELL APPR:FSM/TH 2008/09/05 2008/09/11 2008/09/11	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
		mm INCH		DRAWN BY JTR	DATE 1993/10/18	LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED		
		4 PLACES ± --- ± --- 3 PLACES ± --- ± .015 2 PLACES ± 0.38 ± --- 1 PLACE ± --- ± ---		CHECKED BY JTR	DATE 1993/10/18			
		ANGULAR ± 1/2°		APPROVED BY RAS	DATE 1993/10/18			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO. SEE SHTS 3	DOCUMENT NO. SDA-43223	SHEET NO. 2 OF 6	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



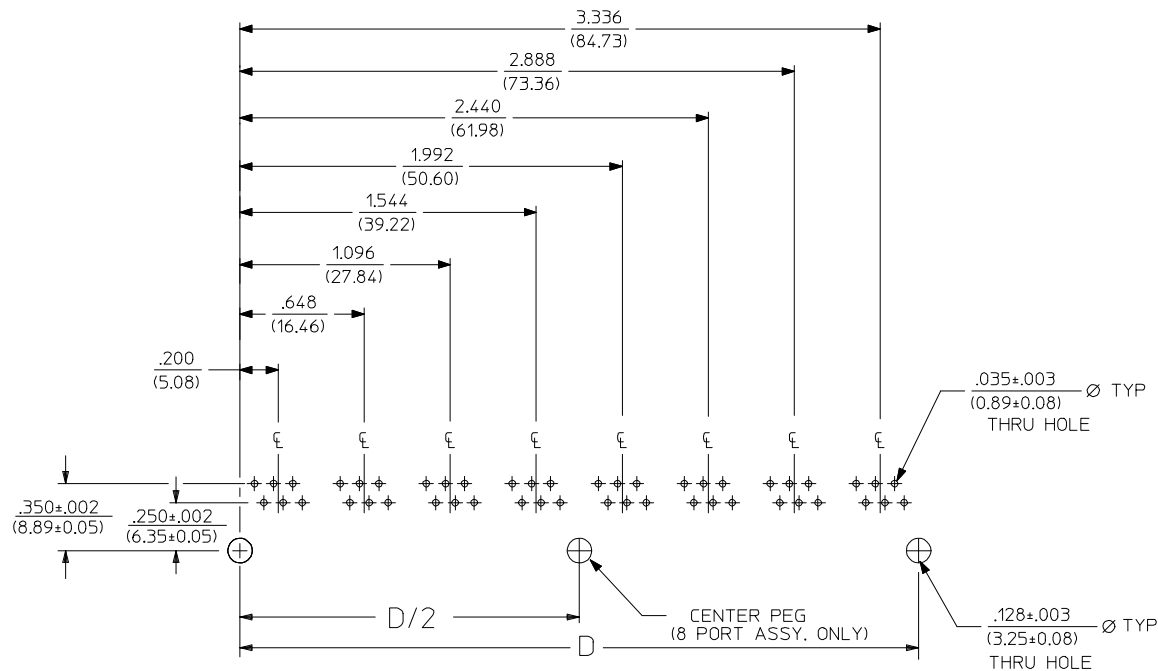
6 LOADED 2 DETAIL
SCALE: 4/1



6 LOADED 4 DETAIL
SCALE: 4/1



6 LOADED 6 DETAIL
SCALE: 4/1

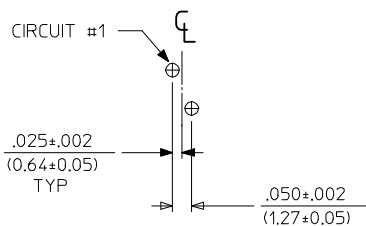


SUGGESTED P.C. BOARD LAYOUT
COMPONENT SIDE OF BOARD
8 PORT, 6 LOADED 6, LAYOUT SHOWN
(SNAP-FIT VERSIONS)

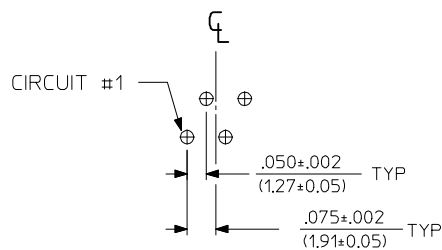
NOTES:
1. RECOMMENDED PCB THICKNESS .062±.005/(1.57±0.13)

NUMBER OF PORTS	DIM. D
2	.848 (21.54)
3	1.296 (32.92)
4	1.744 (44.30)
5	2.192 (55.68)
6	2.640 (67.06)
8	3.536 (89.81)

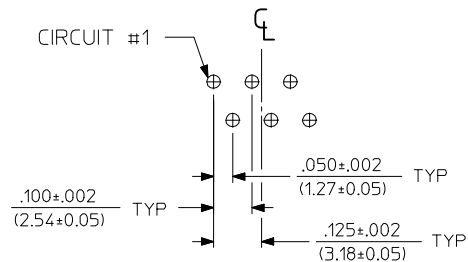
SEE SHEET 1 EC NO: UCP2009-0477 DRWN:JBELL 2008/09/05 CHKD:JBELL 2008/09/11 APPR:FSM TH 2008/09/11 K1	REV	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 2:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION			
					mm	INCH	DRAWN BY JTR	DATE 1993/10/18	TITLE LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY				
				4 PLACES	± ---	± ---	CHECKED BY JTR	DATE 1993/10/18					
				3 PLACES	± ---	± .015	APPROVED BY	DATE					
				2 PLACES	± 0.38	± ---	RAS	1993/10/18	 MOLEX INCORPORATED				
				1 PLACE	± ---	± ---	MATERIAL NO. SEE SHT 3				DOCUMENT NO. SDA-43223		
				ANGULAR ±1/2°			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SHEET NO. 4 OF 6				
				SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							



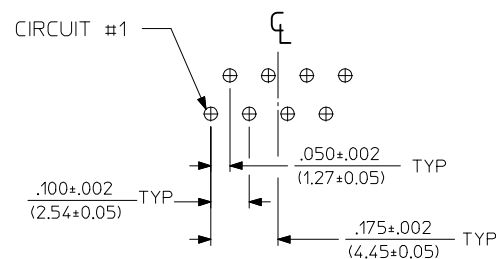
8 LOADED 2 DETAIL
SCALE: 4/1



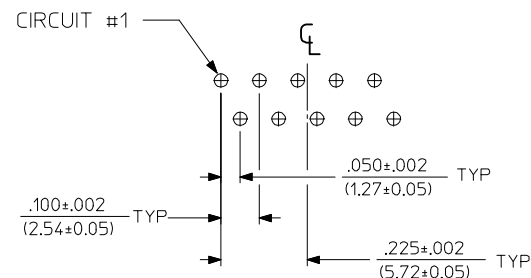
8 LOADED 4 DETAIL
SCALE: 4/1



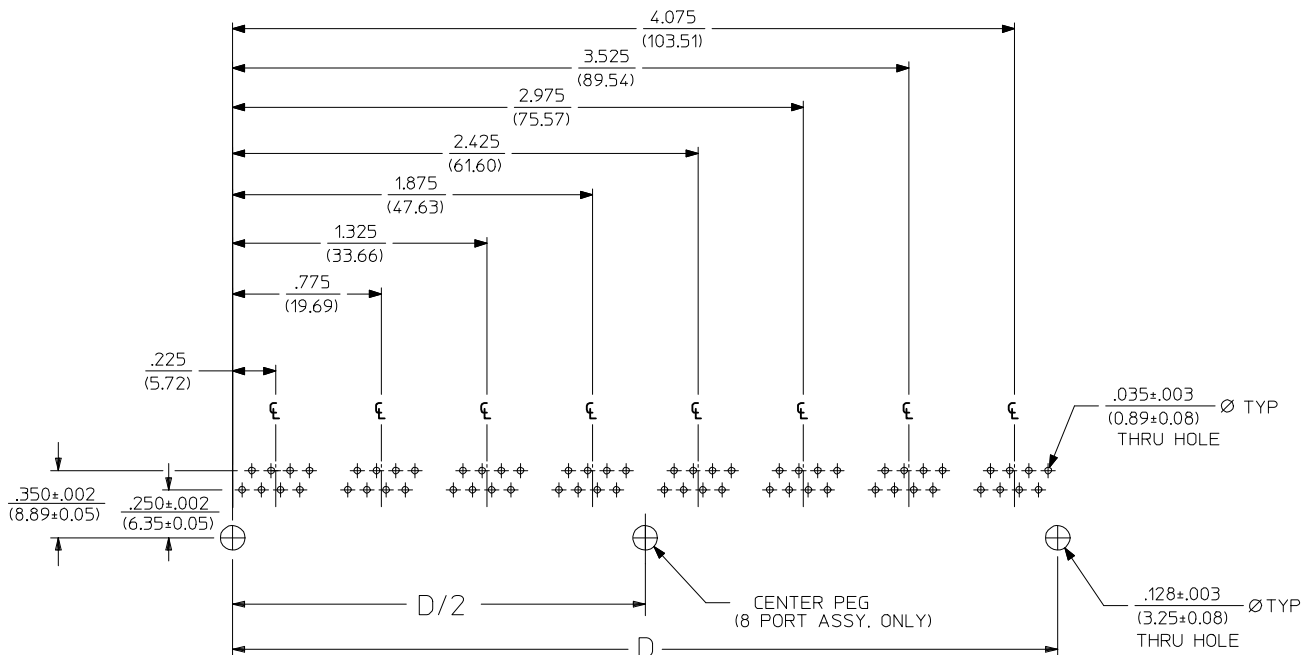
8 LOADED 6 DETAIL
SCALE: 4/1



8 LOADED 8 DETAIL
SCALE: 4/1



8 LOADED 10 DETAIL
SCALE: 4/1



SUGGESTED P.C. BOARD LAYOUT
COMPONENT SIDE OF BOARD
8 PORT, 8 LOADED 8
(SNAP-FIT VERSIONS)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

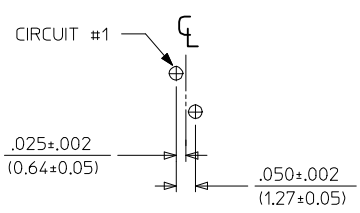
NUMBER OF PORTS	DIM. D
2	1.000 (25.40)
3	1.550 (39.37)
4	2.100 (53.34)
5	2.650 (67.31)
6	3.200 (81.28)
8	4.300 (109.32)

SEE SHEET 1	EC NO: UCP2009-0477	2008/09/05	DRWN:JBELL	2008/09/11	CHKD:JBELL	2008/09/11	APPR:FSM/TH	2008/09/11
K1	REV	DESCRIPTION	QUALITY SYMBOLS	▽=0	▽=0			

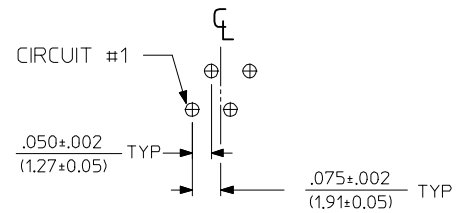
GENERAL TOLERANCES (UNLESS SPECIFIED)	
mm	INCH
4 PLACES ± ---	± ---
3 PLACES ± ---	± .015
2 PLACES ± 0.38	± ---
1 PLACE ± ---	± ---
ANGULAR ± 1/2°	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE IN/MM	
DRAWN BY	DATE
JTR	1993/10/18
CHECKED BY	DATE
JTR	1993/10/18
APPROVED BY	DATE
RAS	1993/10/18
MATERIAL NO.	DOCUMENT NO.
SEE SHT 3	SDA-43223
SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
C	

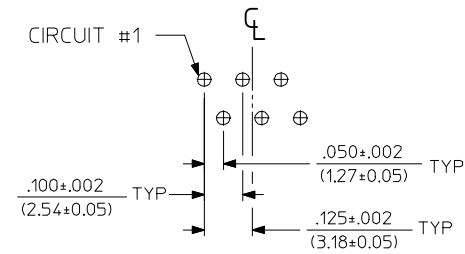
SCALE 2:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
TITLE		
LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY		
MOLEX INCORPORATED		
SHEET NO. 5 OF 6		



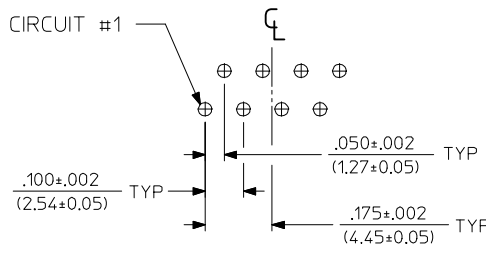
8 LOADED 2 DETAIL
SCALE: 4/1



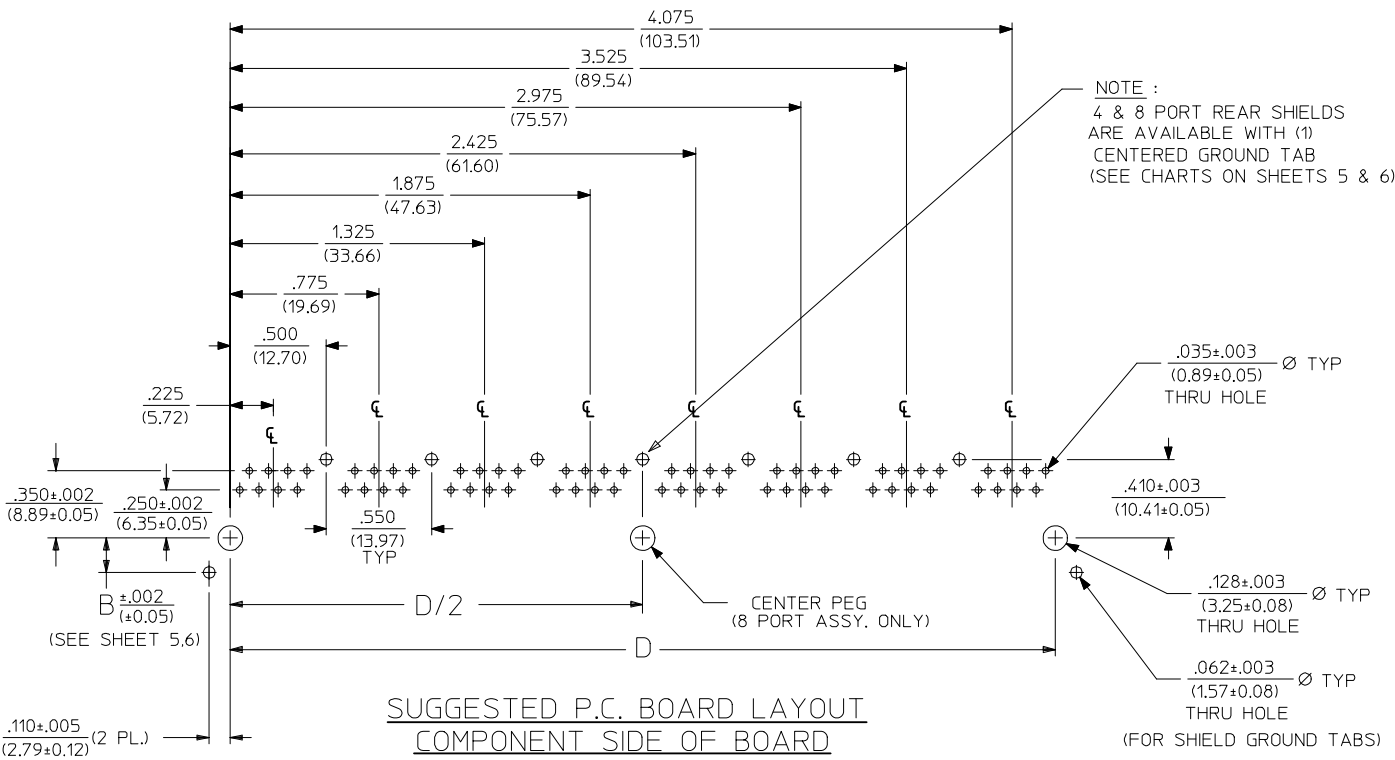
8 LOADED 4 DETAIL
SCALE: 4/1



8 LOADED 6 DETAIL
SCALE: 4/1



8 LOADED 8 DETAIL
SCALE: 4/1



NOTE :
4 & 8 PORT REAR SHIELDS
ARE AVAILABLE WITH (1)
CENTERED GROUND TAB
(SEE CHARTS ON SHEETS 5 & 6)

SUGGESTED P.C. BOARD LAYOUT
COMPONENT SIDE OF BOARD
8 PORT, 8 LOADED 8
(SHIELDED) LAYOUT SHOWN
(SNAP-FIT VERSIONS)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

NUMBER OF PORTS	DIM. D
2	1.000 (25.40)
4	2.100 (53.34)
6	3.200 (81.28)
8	4.300 (109.32)

SEE SHEET 1	EC NO: UCP2009-0477	2008/09/05
	DRWN:JBELL	2008/09/11
	CHKD:JBELL	2008/09/11
	APPR:FSM/TH	2008/09/11
REV	DESCRIPTION	
K1		

QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)
▽=0	
▽=0	
	mm
	INCH
	4 PLACES ± --- ± ---
	3 PLACES ± --- ± .015
	2 PLACES ± 0.38 ± ---
	1 PLACE ± --- ± ---
	ANGULAR ± 1/2°
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE	SCALE	DESIGN UNITS
IN/MM	2:1	INCH
DRAWN BY	DATE	
JTR	1993/10/18	
CHECKED BY	DATE	
JTR	1993/10/18	
APPROVED BY	DATE	
RAS	1993/10/18	
MATERIAL NO.		
SEE SHT 3		
SIZE		

TITLE	THIRD ANGLE PROJECTION
LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY	
MOLEX INCORPORATED	
DOCUMENT NO.	SHEET NO.
SDA-43223	6 OF 6
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9